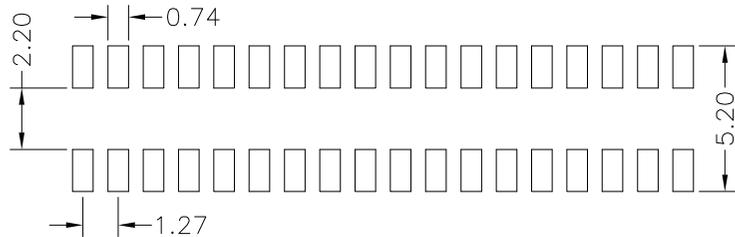
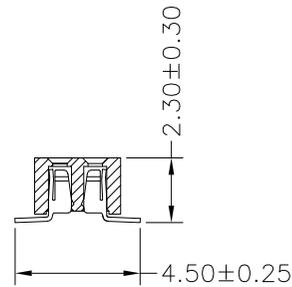
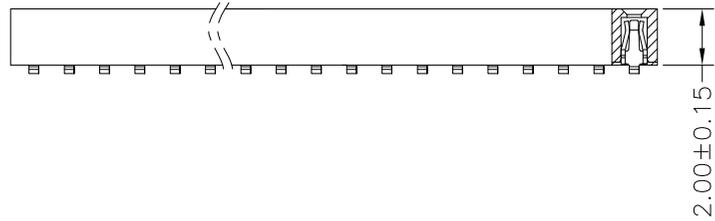
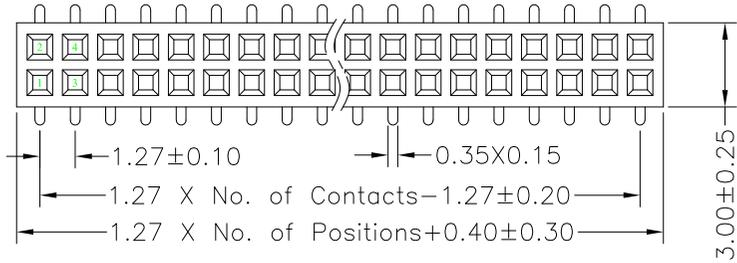


GP Component

REV.	ECN NO.	LOCATIONS	DESCRIPTION	DATE	DESIGN
A0			Initial	2020/08/31	Hanson



RECOMMENDED P.C.B LAYOUT

Material:

Contact Material: Brass

Contact plating: G/F plated ON Contact Area, Over 50μ" Ni

Insulator Material: Black Polyester UL94V-0

Standard: PA6T+30%G.F

Electrical:

Current rating: 1.0Amps/contact max.

Contact resistance: ≤20mΩ/contact

Insulation resistance: ≥500MΩ at V=100V

Withstanding Voltage: 300V AC/minute

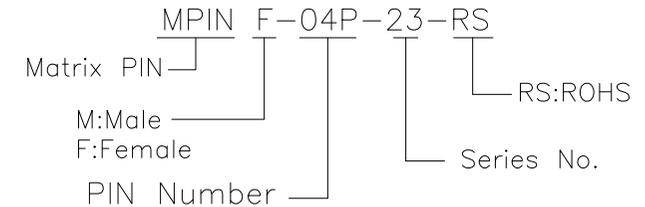
Mechanical:

Mechanical life cycle: min.200

Operating temperatures: -55°C to +105°C

Soldering temperature: +260°C max(PA6T)

MATRIX PART NO:



 Matrix Electronics Co.,Ltd

TOLERANCE: X.X ±0.38 X.XX ±0.25 X.XXX ±0.15 ANGLE: ±5°	DESIGN BY :	DATE :	PART NAME:	
	Hanson Huang	2020/08/31	PITCH=1.27MM 2*2P PIN HEADER	
 UNIT: mm [inch]	CHECKED BY:	DATE :	PART NO.	MPINF-04P-23-RS
	Vicky Hsieh	2020/08/31		
SCALE:1:1 SIZE:A4	APPROVED BY1:	DATE :	MOLD NO.	NA
	Richard Hsieh	2020/08/31		
	APPROVED BY2:	DATE :	DRAW NO.	
	Richard Hsieh	2020/08/31	SHEET NO.	1 OF 1